

CRMGTU0101A

N-Channel 12V, 1.5mΩ Typ. Power MOSFET

Description



• 12V, 100A

 $R_{DS(ON)}$ Typ = 1.5m Ω @ V_{GS} = 4.5V

 $R_{DS(ON)}$ Typ = 2.0m Ω @ V_{GS} = 2.5V

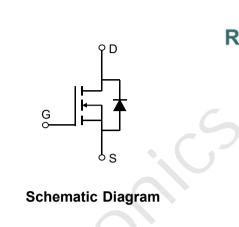
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

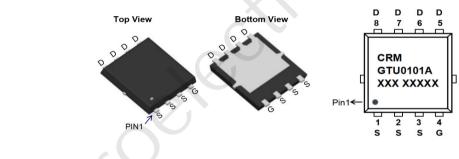
Application

PWM Application

• Power Management

· Load Switch





Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGTU0101A	CRMGTU0101A	PDFN5x6-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		12	V
V _{GS}	Gate-to-Source Voltage		±12	V
	Continuous Drain Current	$T_c = 25^{\circ}C$	100	А
Ι _D		T _C = 100°C	60	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		400	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		20	mJ
P _D	Power Dissipation	T _C = 25°C	31	W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case		4.0	°C/W
Τ J, T _{STG}	Junction & Storage Temperature Range		-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{\rm D}$ = 250 μ A, V _{GS} = 0V	12	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 12V, V _{GS} = 0V	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 12V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.4	0.6	1.0	V
_		V_{GS} = 4.5V, I _D = 20A	-	1.5	2.0	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 2.5V, I _D = 10A	-	2.0	2.6	mΩ
Jynamic	Characteristics					
C _{iss}	Input Capacitance		-	4940	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 6V, f = 1MHz	Χ-	1228	-	pF
C _{rss}	Reverse Transfer Capacitance			1128	-	pF
Qg	Total Gate Charge	0	<u> </u>	50	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 4.5V$ $V_{DS} = 10V, I_{D} = 20A$	-	8	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$v_{\rm DS} = 10$ V, $I_{\rm D} = 20$ A	-	20	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	15	-	ns
t _r	Turn-On Rise Time	V _{GS} = 4.5V, V _{DD} = 10V	-	40	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 3 Ω	-	80	-	ns
t _f	Turn-Off Fall Time		-	85	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _S	Maximum Continuous Drain to Source Diode Forward Current			-	100	А
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	400	А
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 20A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	30	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 20A, di/dt = 100A/us	-	20	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting T_J=25°C, V_{DD}=6V, V_G=10V, R_G=25ohm, L=0.5mH, I_{AS}=9A

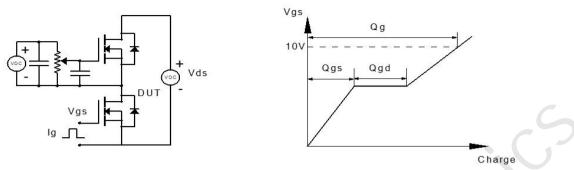
3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 0.5%.

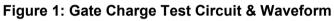


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Test Circuit





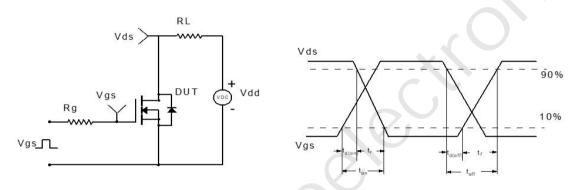
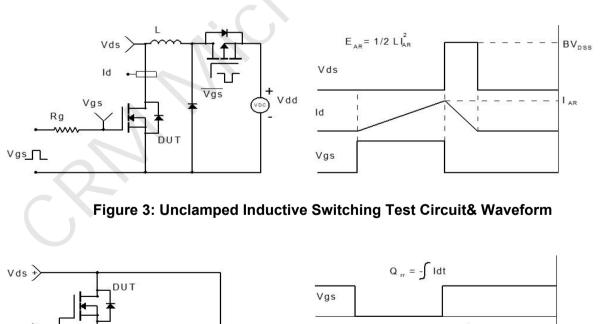


Figure 2: Resistive Switching Test Circuit & Waveform



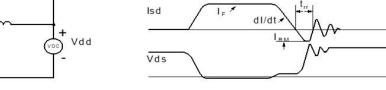


Figure 4: Diode Recovery Test Circuit & Waveform

L

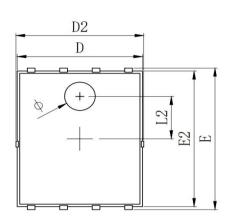
Vds

Ig

Vdd

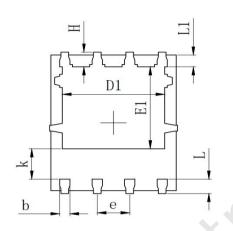


Package Mechanical Data(PDFN5x6-8L)



Al

A2



SYMBOL	MILLIMETER				
SIMBUL	MIN	Typ.	MAX		
Α	0.900	1.000	1.100		
A1	0.254 REF.				
A2	0~0.05				
D	4.824	4.900	4.976		
D1	3. <mark>910</mark>	4.010	4. 110		
D2	4.924	5.000	5.076		
Е	5. <mark>9</mark> 24	6.000	6.076		
E1	3. 375	3.475	3. 575		
E2	5.674	5.750	5.826		
b	0.350	0.400	0.450		
е	1.270 TYP.				
L	0. 534	0.610	0.686		
L1	0. 424	0. 500	0.576		
L2	1.800 REF.				
k	1. 190	1.290	1. 390		
Н	0.549	0.625	0.701		
θ	8°	10°	12°		
ф	1.100	1.200	1.300		
d			0.100		

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Contact information

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